DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION

As a below named Inven	or, I hereby declare that:
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As a below named inventor, I nereby declare that:		
My residence, post office address, and citizenship are as stated below next to my name.	•	
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first a names are listed below) of the subject matter which is claimed and for which patent is sought on the inv METHOD FOR FORMING UBM PADS AND BUMPS ON WAFER	nd joint invento ention entitled:	er (if plural
the specification of which is attached hereto OR was filed on Number and was amended on (if applicable). or PCT I	nternational Ap	plication
I hereby state that I have reviewed and understand the contents of the above identified specification, incl by any amendment specifically referred to above.	uding the claim	s, as amended
I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1	.56.	
I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application (scertificate, or 365(a) of any PCT international application which designated at least one country other the America, listed below and have also identified below, by checking the box, any foreign application for p or of any PCT international application having a filing date before that of the application on which priori	an the United Statent or invento	tates of

Prior Foreign Application No.	Country		Foreign Filing Date	Priority Claimed Certified		d Copy Attached	
		• •	(MM/DD/YYYY)	Yes	No	Yes	No
091175242	Republic of China		11/29/2002	X		X	
	'						
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I hereby claim the benefit under 35 U.S.C. 119(e) of a United States provisional application(s) listed below. **Application Number** Filing Date (MM/DD/YYYY)

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

U.S. or PCT Parent Application No.	Parent Filing Date (MM/DD/YYYY)	Parent Patent No. (if applicable)
		:

As a named inventor, I hereby appoint the following registered practitioner(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or Imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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